

FGP5N60LS

600 V, 5 A Field Stop IGBT

Features

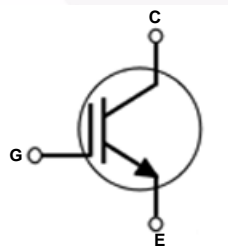
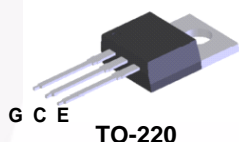
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.7 \text{ V}$ @ $I_C = 5 \text{ A}$
- High Input Impedance
- RoHS Compliant

Applications

- HID Ballast

General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop IGBTs offer the optimum performance for HID ballast where low conduction losses are essential.



Absolute Maximum Ratings

Symbol	Description	Ratings	Unit
V_{CES}	Collector to Emitter Voltage	600	V
V_{GES}	Gate to Emitter Voltage	± 20	V
I_C	Collector Current @ $T_C = 25^\circ\text{C}$	10	A
	Collector Current @ $T_C = 100^\circ\text{C}$	5	A
$I_{CM} (1)$	Pulsed Collector Current @ $T_C = 25^\circ\text{C}$	36	A
P_D	Maximum Power Dissipation @ $T_C = 25^\circ\text{C}$	83	W
	Maximum Power Dissipation @ $T_C = 100^\circ\text{C}$	33	W
T_J	Operating Junction Temperature	-55 to +150	$^\circ\text{C}$
T_{stg}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$
T_L	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

Notes:

1: Repetitive test, Pulse width = 100 usec, Duty = 0.2, $V_{GE} = 13.5 \text{ V}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	-	1.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	62.5	$^\circ\text{C/W}$

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGP5N60LS	FGP5N60LS	TO-220	Tube	N/A	N/A	50

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	600	-	-	V
$\frac{\Delta BV_{CES}}{\Delta T_J}$	Temperature Coefficient of Breakdown Voltage	V _{GE} = 0 V, I _C = 250 μA	-	0.8	-	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μA
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0 V	-	-	±400	nA
On Characteristics						
V _{GE(th)}	G-E Threshold Voltage	I _C = 250 μA, V _{CE} = V _{GE}	2.7	3.9	4.5	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 5 A, V _{GE} = 15 V	-	1.7	2.1	V
		I _C = 5 A, V _{GE} = 15 V, T _C = 125°C	-	1.8	-	V
	Collector to Emitter Saturation Voltage	I _C = 14 A, V _{GE} = 12 V	-	2.7	3.2	V
		I _C = 14 A, V _{GE} = 12 V, T _C = 125°C	-	3.1	-	V
Dynamic Characteristics						
C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	278	-	pF
C _{oes}	Output Capacitance		-	28	-	pF
C _{res}	Reverse Transfer Capacitance		-	11	-	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{CC} = 400 V, I _C = 5 A, R _G = 10 Ω, V _{GE} = 15 V, Inductive Load, T _C = 25°C	-	4.3	-	ns
t _r	Rise Time		-	1.6	-	ns
t _{d(off)}	Turn-Off Delay Time		-	36	-	ns
t _f	Fall Time		-	118	-	ns
E _{on}	Turn-On Switching Loss		-	38	-	μJ
E _{off}	Turn-Off Switching Loss		-	130	-	μJ
E _{ts}	Total Switching Loss		-	168	-	μJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 400 V, I _C = 5 A, R _G = 10 Ω, V _{GE} = 15 V, Inductive Load, T _C = 125°C	-	4.1	-	ns
t _r	Rise Time		-	1.8	-	ns
t _{d(off)}	Turn-Off Delay Time		-	37	-	ns
t _f	Fall Time		-	150	-	ns
E _{on}	Turn-On Switching Loss		-	80	-	μJ
E _{off}	Turn-Off Switching Loss		-	168	-	μJ
E _{ts}	Total Switching Loss		-	248	-	μJ
Q _g	Total Gate Charge	V _{CE} = 400 V, I _C = 5 A, V _{GE} = 15 V	-	18.3	-	nC
Q _{ge}	Gate to Emitter Charge		-	1.6	-	nC
Q _{gc}	Gate to Collector Charge		-	7.9	-	nC

Typical Performance Characteristics

Figure 1. Typical Output Characteristics

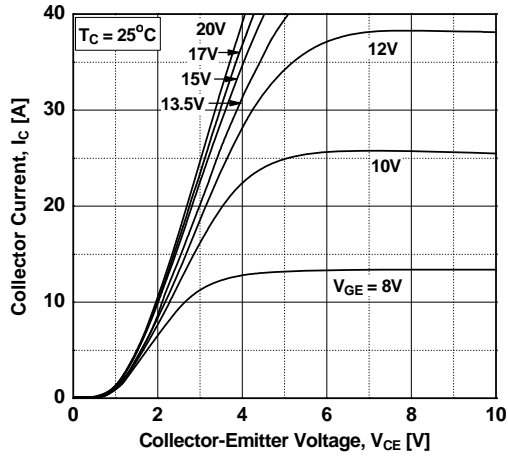


Figure 2. Typical Output Characteristics

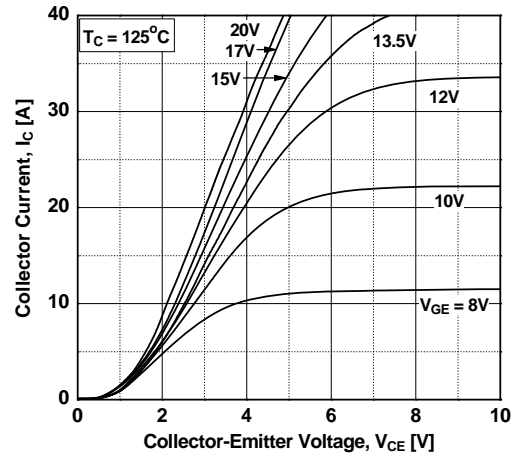


Figure 3. Typical Saturation Voltage Characteristics

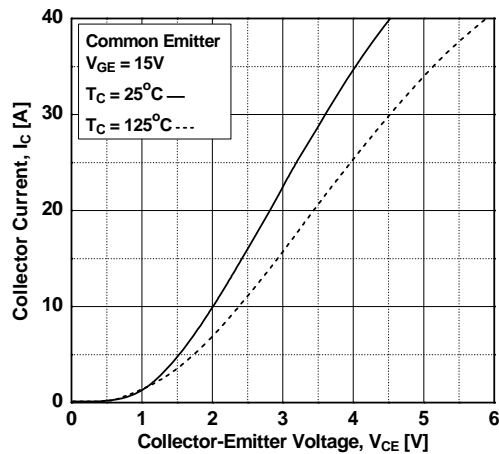


Figure 4. Transfer Characteristics

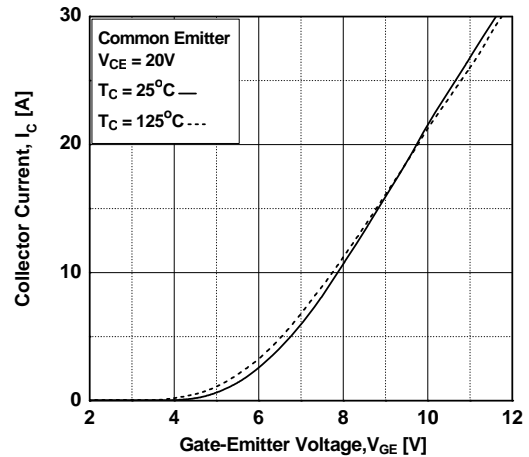


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level

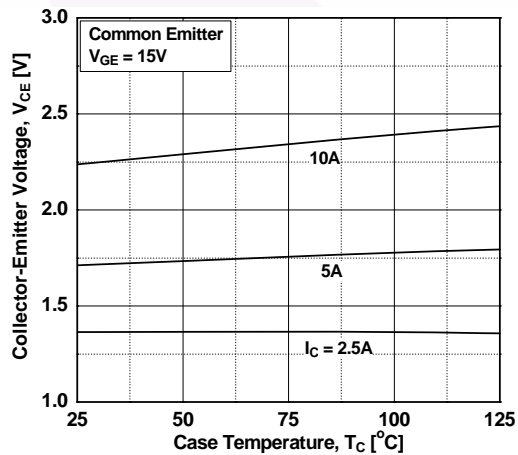
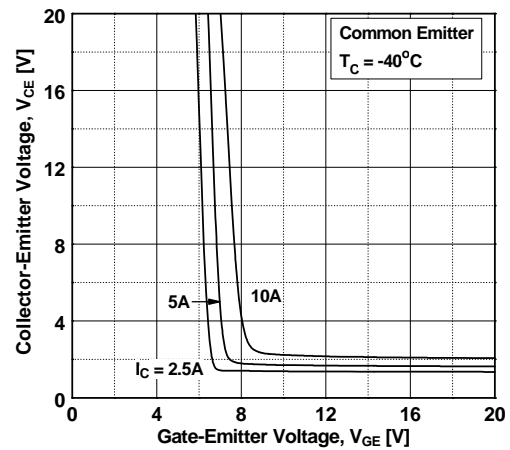


Figure 6. Saturation Voltage vs. V_GE



Typical Performance Characteristics

Figure 7. Saturation Voltage vs. V_{GE}

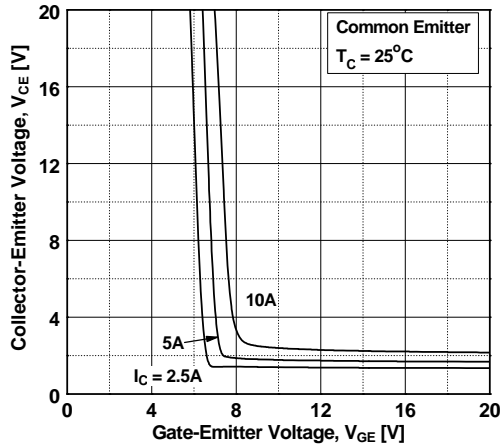


Figure 8. Saturation Voltage vs. V_{GE}

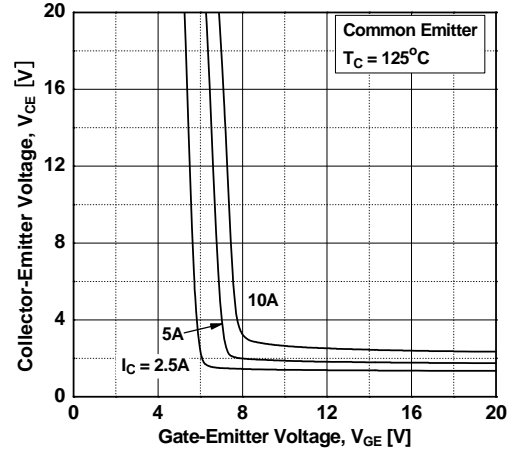


Figure 9. Capacitance Characteristics

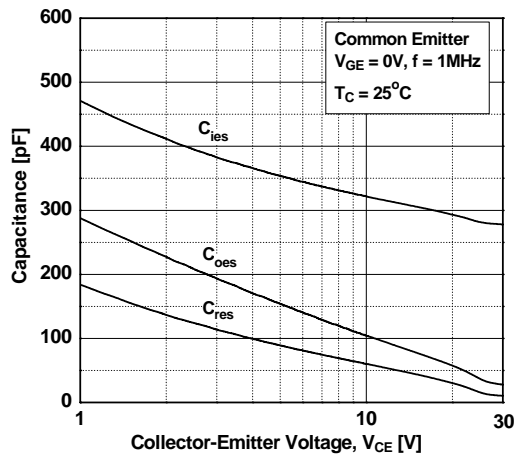


Figure 10. Gate charge Characteristics

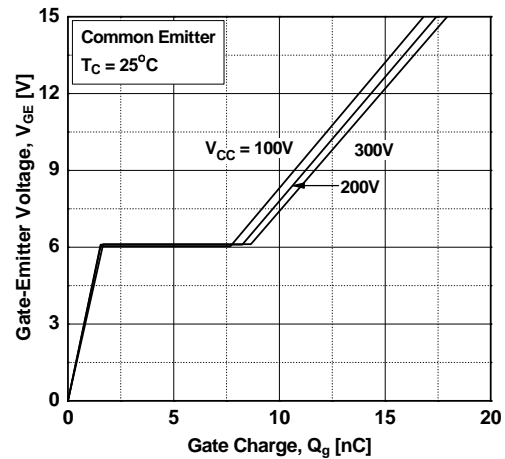


Figure 11. SOA Characteristics

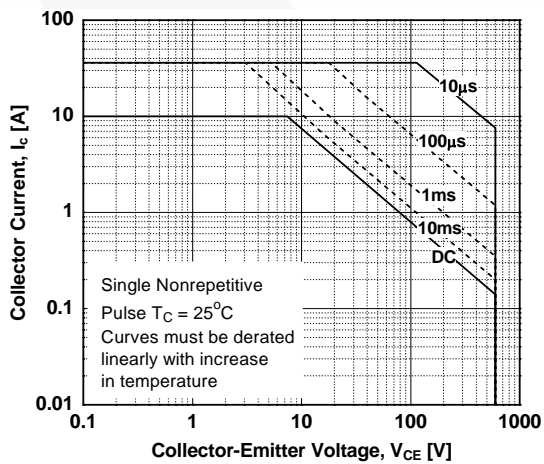
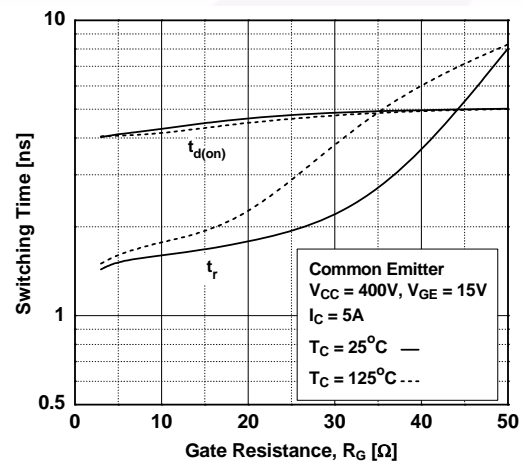


Figure 12. Turn-on Characteristics vs. Gate Resistance



Typical Performance Characteristics

Figure 13. Turn-off Characteristics vs. Gate Resistance

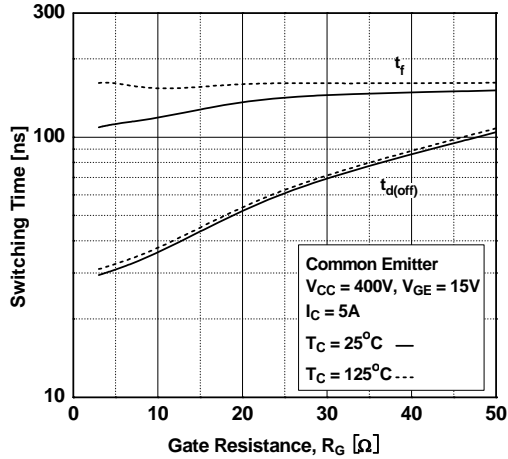


Figure 14. Turn-on Characteristics vs. Collector Current

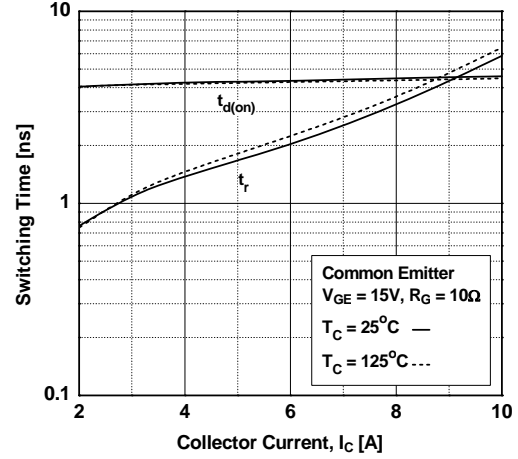


Figure 15. Turn-off Characteristics vs. Collector Current

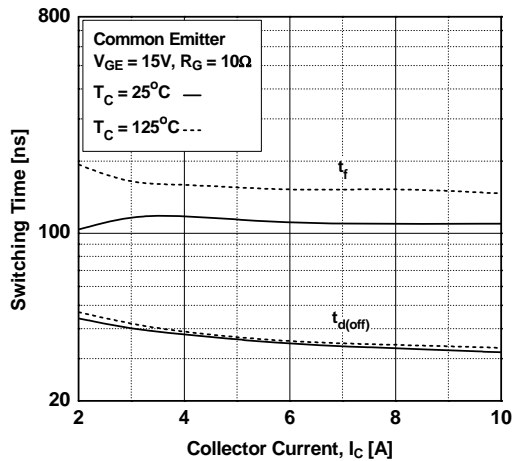


Figure 16. Switching Loss vs. Gate Resistance

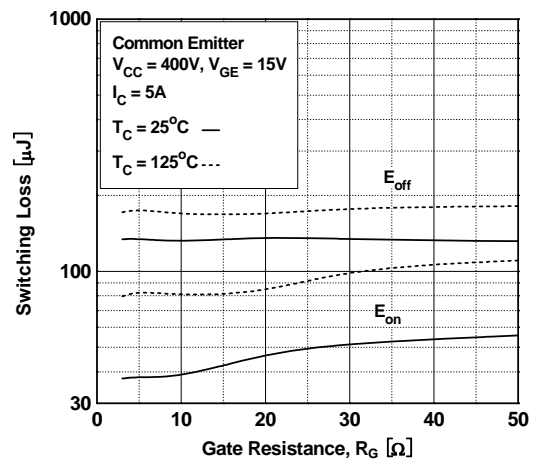


Figure 17. Switching Loss vs. Collector Current

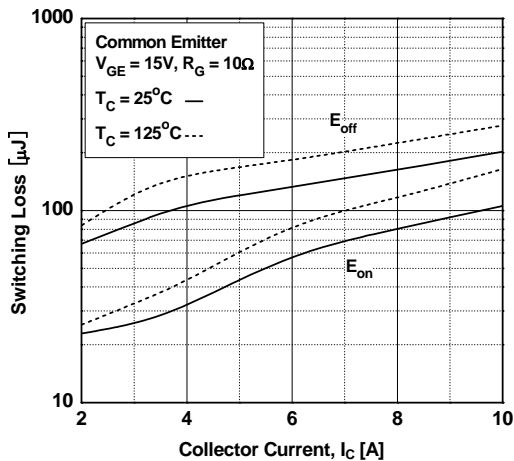
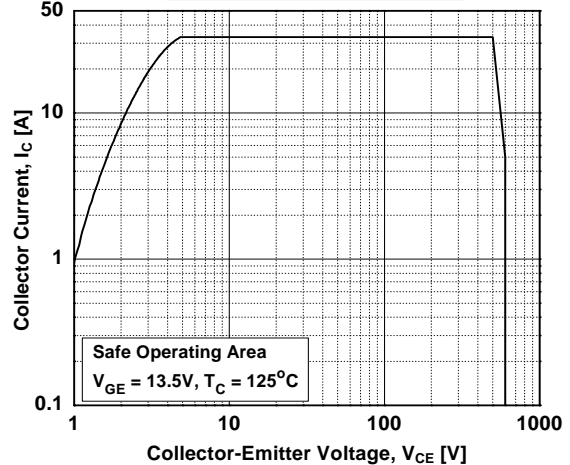
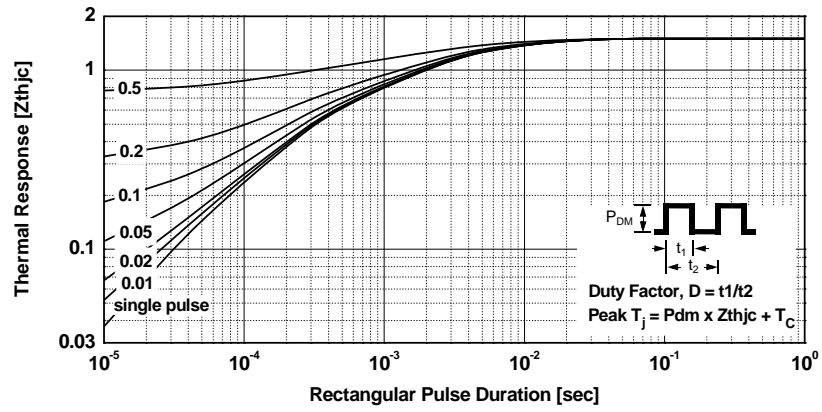


Figure 18. Turn off Switching SOA Characteristics



Typical Performance Characteristics

Figure 19. Transient Thermal Impedance of IGBT



Mechanical Dimensions

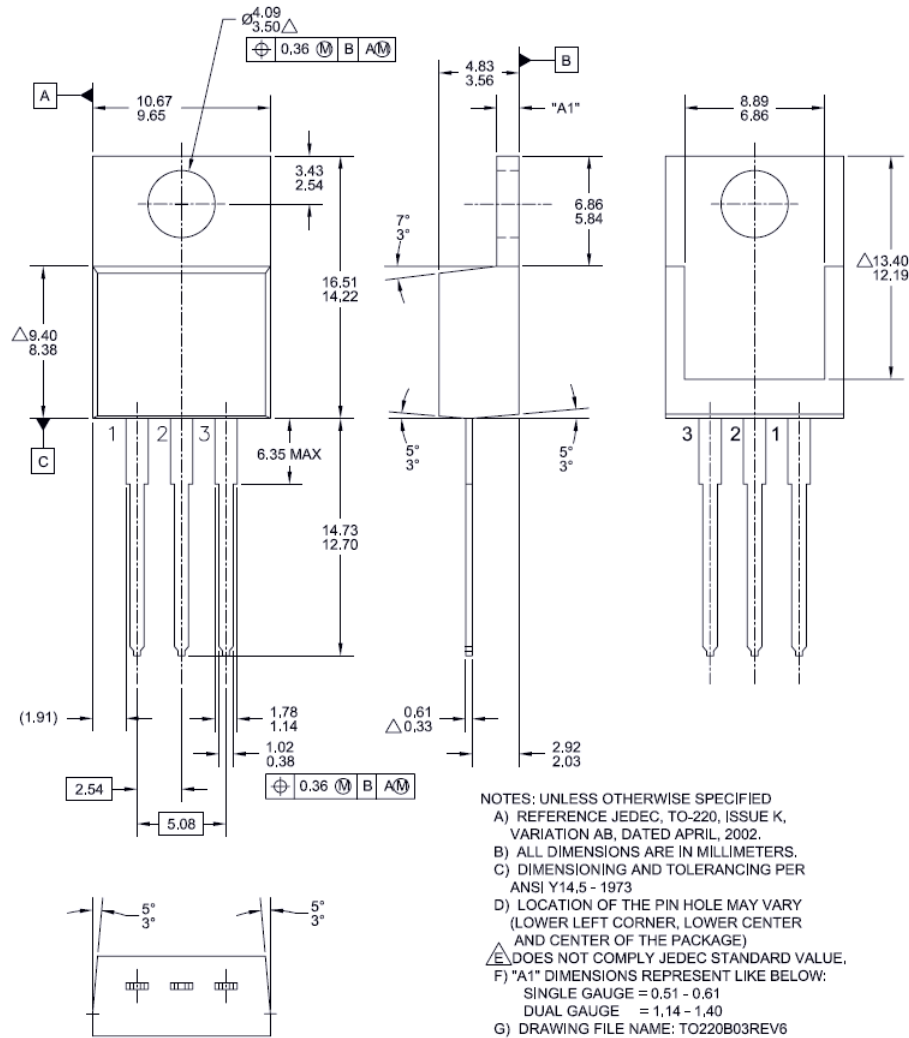


Figure 20. TO-220 3L - TO-220, MOLDED, 3LEAD, JEDEC VARIATION AB

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